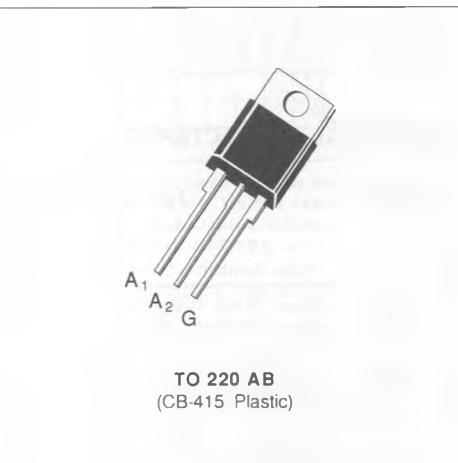


SNUBBERLESS TRIACS

- $I_{TRMS} = 6 \text{ A}$ at $T_c = 95^\circ\text{C}$.
- V_{DRM} : 200 V to 800 V.
- $I_{GT} = 75 \text{ mA}$ (QI-II-III).
- GLASS PASSIVATED CHIP.
- HIGH SURGE CURRENT : $I_{TSM} = 60 \text{ A}$.
- HIGH COMMUTATION CAPABILITY : $(di/dt)_c > 8 \text{ A / ms}$ without snubber.
- INSULATING VOLTAGE : 2500 V_{RMS}.


DESCRIPTION

New range suited for applications such as phase control and static switching on inductive or resistive load.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value		Unit
I_{TRMS}	RMS on-state current (360 ° conduction angle)	$T_c = 95^\circ\text{C}$	6	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25 °C)	$t = 8.3 \text{ ms}$	63	A
		$t = 10 \text{ ms}$	60	
$I^2 t$	$I^2 t$ value	$t = 10 \text{ ms}$	18	$\text{A}^2 \text{ s}$
di/dt	Critical rate of rise of on-state current (1)	Repetitive $F = 50 \text{ Hz}$	20	$\text{A}/\mu\text{s}$
		Non Repetitive	100	
T_{stg} T_j	Storage and operating junction temperature range	$-40, +150$ $-40, +125$		$^\circ\text{C}$ $^\circ\text{C}$

Symbol	Parameter	BTA 06-					Unit
		200 AW	400 AW	600 AW	700 AW	800 AW	
V_{DRM}	Repetitive peak off-state voltage (2)	± 200	± 400	± 600	± 700	± 800	V

(1) Gate supply : $I_G = 750 \text{ mA}$ – $di_G / dt = 1 \text{ A} / \mu\text{s}$.

(2) $T_j = 125^\circ\text{C}$.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient	60	°C/W
$R_{th(j-c)} \text{ DC}$	Junction to case for DC	4.3	°C/W
$R_{th(j-c)} \text{ AC}$	Junction to case for 360° conduction angle ($F = 50 \text{ Hz}$)	3.2	°C/W

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 40 \text{ W}$ ($t = 10 \mu\text{s}$) $P_{G(AV)} = 1 \text{ W}$ $I_{GM} = 4 \text{ A}$ ($t = 10 \mu\text{s}$) $V_{GM} = 16 \text{ V}$ ($t = 10 \mu\text{s}$).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25^\circ\text{C}$	$V_D = 12 \text{ V}$	$R_L = 33 \Omega$	I-II-III	2	75	mA
	Pulse duration > 20 μs						
V_{GT}	$T_j = 25^\circ\text{C}$	$V_D = 12 \text{ V}$	$R_L = 33 \Omega$	I-II-III		1.5	V
	Pulse duration > 20 μs						
V_{GD}	$T_j = 125^\circ\text{C}$	$V_D = V_{DRM}$	$R_L = 3.3 \text{ k}\Omega$	I-II-III	0.2		V
	Pulse duration > 20 μs						
I_H^*	$T_j = 25^\circ\text{C}$	$I_T = 100 \text{ mA}$	$R_L = 140 \Omega$			75	mA
	Gate open						
I_I	$T_j = 25^\circ\text{C}$	$V_D = 12 \text{ V}$	$I_G = 500 \text{ mA}$	I-III		75	
	Pulse duration > 20 μs			II		150	mA
V_{TM}^*	$T_j = 25^\circ\text{C}$	$I_{TM} = 8.5 \text{ A}$	$t_p = 10 \text{ ms}$			1.75	V
I_{DRM}^*	$T_j = 25^\circ\text{C}$	V_{DRM} rated	Gate open			0.01	
	$T_j = 125^\circ\text{C}$					2	mA
dv/dt^*	$T_j = 125^\circ\text{C}$	Gate open			750	1000	
	Linear slope up to 0.67 V_{DRM}						V/ μs
$(di/dt)_c^*$	$T_j = 125^\circ\text{C}$	V_{DRM} rated			8	16	
	Without snubber						A / ms
t_{gt}	$T_j = 25^\circ\text{C}$	$di_G/dt = 3.5 \text{ A}/\mu\text{s}$	$I_G = 500 \text{ mA}$	I-II-III	2		μs
	$I_T = 8.5 \text{ A}$	$V_D = V_{DRM}$					

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

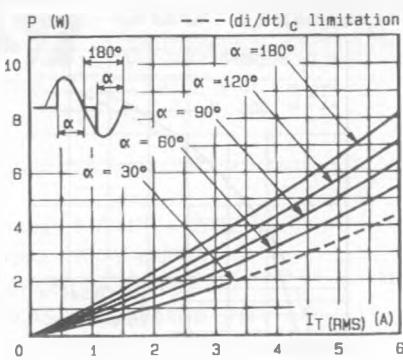


Fig.1 - Maximum mean power dissipation versus RMS on-state current ($F = 60$ Hz).

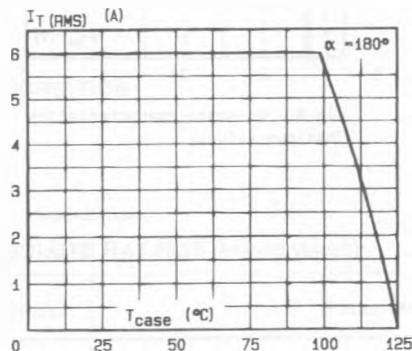


Fig.3 - RMS on-state current versus case temperature.

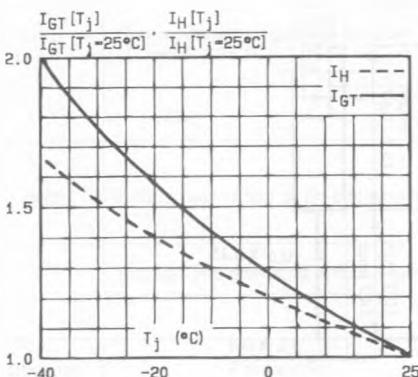


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

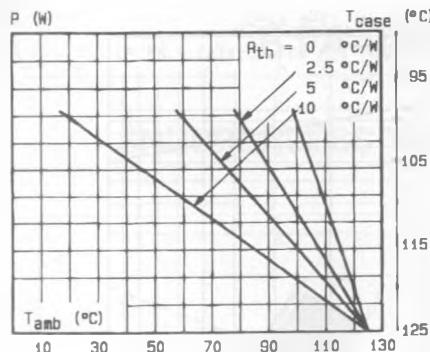


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

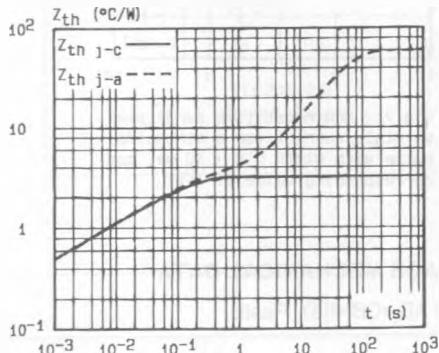


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

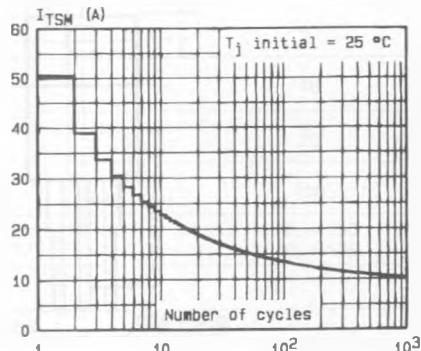


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

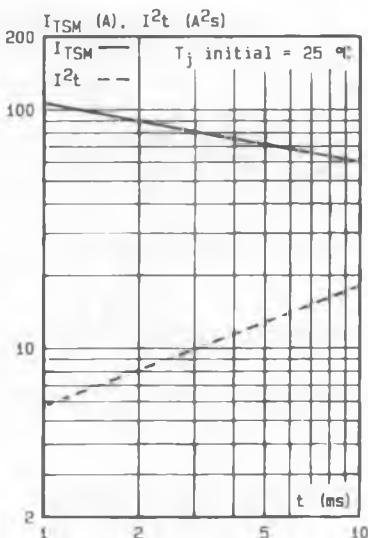


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

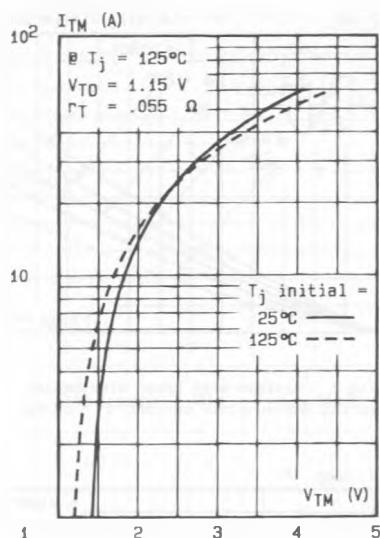
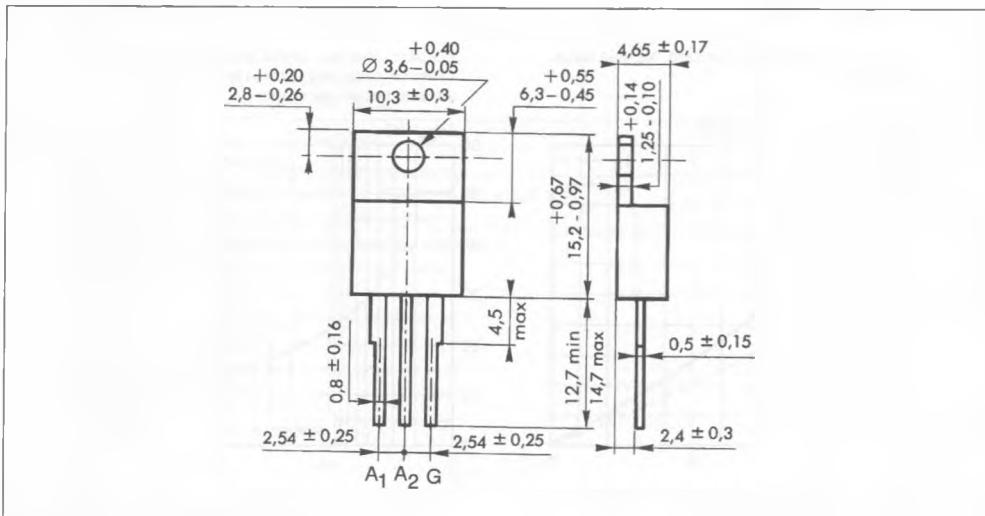


Fig.8 - On-state characteristics (maximum values).

D88BTA06ABCWP4

PACKAGE MECHANICAL DATA

TO 220 AB (CB-415) Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g